

### Part Number: XZMDKVG54W-4

2.0 x 1.25mm SMD Chip LED Lamp

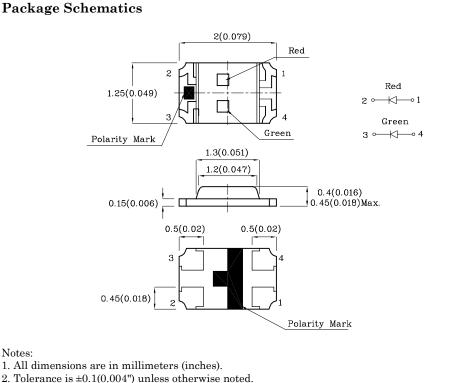
### **Features**

- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 2,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- Halogen-free
- RoHS compliant





ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES



3. Specifications are subject to change without notice.

Notes:

Absolute Maximum Ratings (T <sub>A</sub> =25°C)		Red Green (AlGaInP) (AlGaInP)		Unit
Reverse Voltage	$V_{\rm R}$	5	5	V
Forward Current	$I_{\rm F}$	30	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	185	150	mA
Power Dissipation	$\mathbf{P}_{\mathrm{D}}$	75	75	mW
Operating Temperature	$T_{\rm A}$	-40 ~ +85		°C
Storage Temperature	Tstg	-40 ~ +85		

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Charac (T <sub>A</sub> =25°C)	eteristics		Red (AlGaInP)	Green (AlGaInP)	Unit	
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)		V <sub>F</sub>	1.95	2.1	V	
Forward Voltage (Max.) (I <sub>F</sub> =20mA)		$V_{\rm F}$	2.5	2.5	v	
Reverse Current (Max.) (V <sub>R</sub> =5V)		IR	10	10	μΑ	
Wavelength of Peak Emission CIE127-2007* (Typ.) (I <sub>F</sub> =20mA)		λP	645*	574*	nm	
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I <sub>F</sub> =20mA)		λD	630*	570*	nm	
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)		$ riangle\lambda$	28	20	nm	
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)		С	35	15	pF	
Lens-color	Luminous Intensity CIE127-2007* (I <sub>F</sub> =20mA) mcd		CIE127-2007* A		ewing ngle ) 1/2	
	min.	typ.				
– Water Clear –	120 40*	248 79*	645*		120°	
	20	49	574*	12 574*		

49\*

20\*

\*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

Emitting

Color

Red

Green

Emitting

Material

AlGaInP

AlGaInP

Nov 26,2020

Part

Number

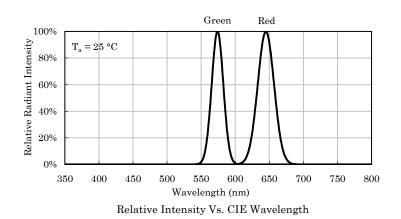
XZMDKVG54W-4

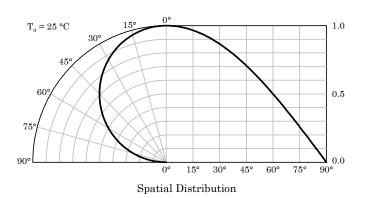
XDSB0168 V12-X Layout: Maggie L.

574\*

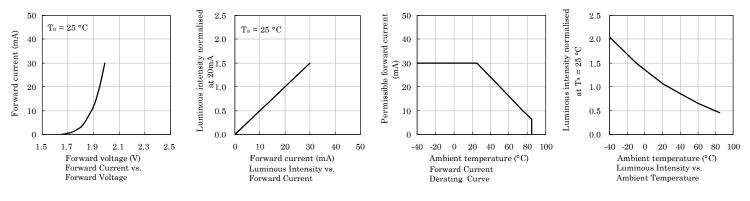


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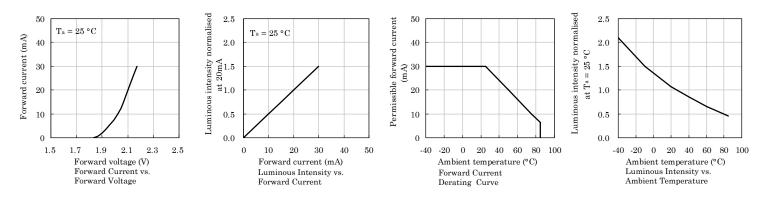






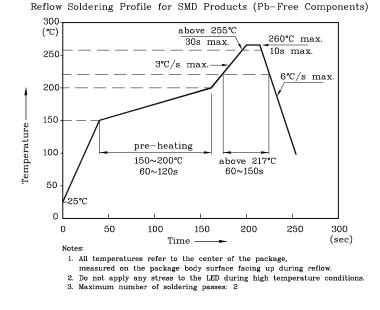


### Green

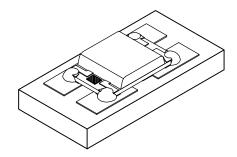




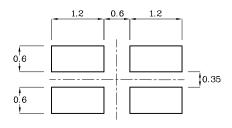
# LED is recommended for reflow soldering and soldering profile is shown below.



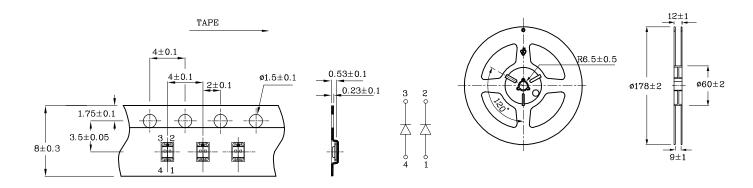
✤ The device has a single mounting surface. The device must be mounted according to the specifications.



Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



### Reel Dimension (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength),

the typical accuracy of the sorting process is as follows:

Tape Specification (Units : mm)

1. Wavelength: +/-1nm

2. Luminous intensity / luminous flux: +/-15%

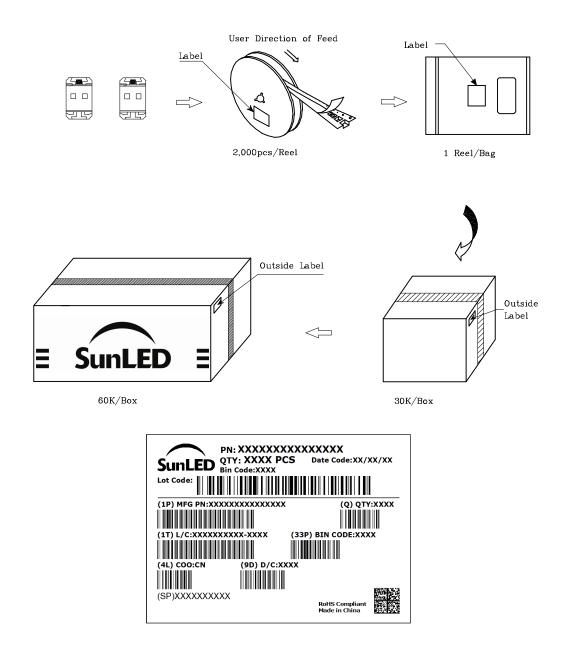
3. Forward Voltage: +/-0.1V  $\,$ 

Note: Accuracy may depend on the sorting parameters.



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## **PACKING & LABEL SPECIFICATIONS**



#### TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet.
- User accepts full risk and responsibility when operating the product(s) beyond their intended specifications. 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please
- consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
- 5. The contents within this document may not be altered without prior consent by SunLED.
- 6. Additional technical notes are available at <u>https://www.SunLEDusa.com/TechnicalNotes.asp</u>

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